SK280MB10



SEMITOP® 3

MOSFET Module

Engineering Sample SK280MB10

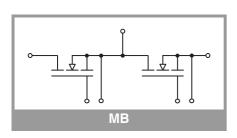
Target Data

Features

- Single leg of inverter
- · Compact design
- One screw mounting module
- Improved thermal performance by aluminum oxide substrate
- · Trench technology
- Short internal connections and low inductance case
- UL recognized, file no. E 63 532

Typical Applications*

- Low switched mode power supplies
- DC servo drives
- UPS



Absolute	Maximum Rati	ngs		
Symbol	Conditions		Values	Unit
MOSFET	•			
V_{DSS}			100	V
I _D	T _i = 175 °C	T _s = 25 °C	278	Α
	$\frac{1}{1}$ = 175 C	T _s = 70 °C	233	Α
I _{DM}			470	Α
I _{DRM}			t.b.d.	Α
V _{GS}			-20 20	V
Tj			-40 175	°C
Integrated	d body diode			•
I _{FM}			470	Α
I _{FRM}			t.b.d.	Α

Absolute Maximum Ratings						
Symbol	Conditions	Values	Unit			
Module						
I _{t(RMS)}		t.b.d.	Α			
T _{stg}		-40 125	°C			
V _{isol}	AC, sinusoidal, t = 1 min	2500	V			

Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
MOSFET							
$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = 2 \text{ mA}$		100			V	
$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 0.55 \text{ mA}$		2	2.7	3.5	V	
I _{DSS}	$V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, T_j = 25 ^{\circ}\text{C}$				0.2	mA	
I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}, T_j = 25 ^{\circ}\text{C}$				200	nA	
$R_{\text{DS(on)}}$	$V_{GS} = 10 \text{ V}$ $I_D = 200 \text{ A}$	T _j = 25 °C		1.15	1.35	$m\Omega$	
				2.1	2.6	mΩ	
C _{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$			22200		pF	
C_{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$ $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}$			3880		pF	
C_{rss}				138		pF	
R _{Gint}	T _j = 25 °C			4.0		Ω	
Q_{G}	$V_{GS} = 0+10 \text{ V}, \text{ V}$	$I_{DD} = 50 \text{ V}, I_{D} = 200 \text{ A}$		310		nC	
t _{d(on)}	V _{DD} = 50 V	T _j = 150 °C				ns	
$t_{d(off)}$	$V_{GS} = 10 \text{ V}$ $I_{D} = 200 \text{ A}$	T _j = 150 °C				ns	
t_{r}		T _j = 150 °C				ns	
t _f		T _j = 150 °C				ns	
E _{on}		T _j = 150 °C		0.35		mJ	
E _{off}		T _j = 150 °C		0.17		mJ	
$R_{th(j-s)}$	per MOSFET			0.68		K/W	
Integrated	d body diode						
$V_F = V_{SD}$	-I _D = 200 A V _{GS} = 0 V chiplevel	T _j = 25 °C		0.88		V	
		T _j = 150 °C		0.77		V	
$V_{F0} = V_{SD0}$	chiplevel	T _j = 25 °C		0.71		V	
		T _j = 150 °C		0.53		V	
$r_F = r_{SD}$	chiplevel	T _j = 25 °C		0.85		mΩ	
		T _j = 150 °C		1.20		mΩ	
t _{rr}	V _{DD} = 50 V -I _D = 200 A					ns	
Q_{rr}						μC	
I _{rr}],,					Α	
E _{rr}	V _{GS} = 10 V			0.036		mJ	

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Characteristics							
Symbol	Conditions	min.	typ.	max.	Unit		
Module							
L _{CE}			t.b.d.		nΗ		
Ms	to heatsink	2.25		2.5	Nm		
W	weight		29		g		

MOSFET Module

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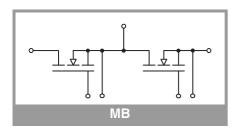
Target Data

Features

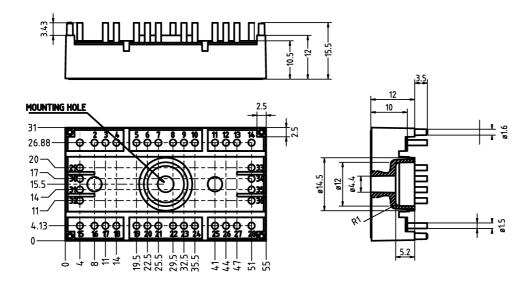
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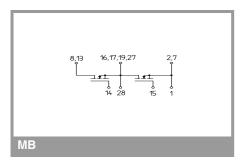
dimensions in mm tolerance system: ISO 2768-m



Suggested hole diameter, in the PCB, for solder pins and mounting plastic pins: 2mm

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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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